1.5 Amp Positive Step-Down

**Integrated Switching Regulator** 

SLTS059A

(Revised 6/30/2000)

V = Vertical Mount

**S** = Surface Mount

**H** = Horizontal

Mount



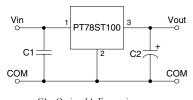
- Very Small Footprint
- High Efficiency > 85%
- Self-Contained Inductor
- Internal Short-Circuit Protection
- Over-Temperature Protection
- Fast Transient Response
- Wide Input Range

The PT78ST100 is a series of wideinput range, 3-terminal regulators.

These ISRs have a maximum output current of 1.5 Amps and an output voltage that is laser trimmed to a variety of industry standard volt-

These 78 series regulators have excellent line and load regulation with internal short- circuit and over-temperature protection, and are offered in a variety of standard output voltages. These ISRs are very flexible and may be used in a wide variety of applications.

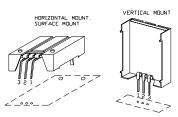
#### **Standard Application**



C1 = Optional 1µF ceramic  $C2 = Required 100\mu F$  electrolytic

#### **Pin-Out Information**

Pin	Function
1	$V_{in}$
2	GND
3	$V_{out}$



SUGGESTED BOARD LAYOUT COMPONENT SIDE VIEW

Pkg Style 500

### **Ordering Information**

PT78ST1	XX	Y	
Output Voltage		Pack	age Suffix

33 = 3.3 Volts**36** = 3.6 Volts

**05** = 5.0 Volts

**51** = 5.1 Volts **53** = 5.25 Volts

**06** = 6.0 Volts

**65** = 6.5 Volts

**07** = 7.0 Volts

**08** = 8.0 Volts

**09** = 9.0 Volts **10** = 10.0 Volts

**12** = 12.0 Volts

**14** = 13.9 Volts

**15** = 15.0 Volts

## **Specifications**

Characteristics			PT78ST.	100 SERIES		
(T <sub>a</sub> = 25°C unless noted)	Symbols	Conditions	Min	Тур	Max	Units
Output Current	$I_{o}$	Over V <sub>in</sub> range	0.1*	_	1.5	A
Short Circuit Current	$I_{sc}$	$V_{in} = V_{in} \min$	_	3.5	_	Apk
Input Voltage Range	$ m V_{in}$	$0.1 \le I_o \le 1.5A$ $V_o = 3.3V$ $V_o = 5V$ $V_o = 12V$	9 9 16	Ξ	26 38 38	V V V
Output Voltage Tolerance	$\Delta { m V_o}$	Over $V_{in}$ range, $I_o$ =1.5A $T_a$ = 0°C to +60°C	_	±1.0	±2.0	%V <sub>o</sub>
Line Regulation	Reg <sub>line</sub>	Over V <sub>in</sub> range	_	±0.2	±0.4	$%V_{o}$
Load Regulation	$Reg_{load}$	$0.1 \le I_o \le 1.5A$	_	±0.1	±0.2	%Vo
V <sub>o</sub> Ripple/Noise	V <sub>n</sub>	$V_{in}$ = 9V, $I_{o}$ = 1.5A $V_{o}$ = 5V $V_{in}$ = 16V, $I_{o}$ = 1.5A $V_{o}$ = 12V		65 90	_	${}^{ m mV_{pp}}_{ m mV_{pp}}$
Transient Response (with 100μF output cap)	t <sub>tr</sub>	$50\%$ load change $V_{\rm o}$ over/undershoot	_	100 5	=	μSec %Vo
Efficiency	η	$\begin{array}{lll} V_{\rm in}\!=\!10 V, I_{\rm o}\!=\!1A & V_{\rm o}\!=\!3.3 V \\ V_{\rm in}\!=\!10 V, I_{\rm o}\!=\!1A & V_{\rm o}\!=\!5 V \\ V_{\rm in}\!=\!17 V, I_{\rm o}\!=\!1A & V_{\rm o}\!=\!12 V \end{array}$	Ξ	80 85 90	=	% % %
Switching Frequency	$f_{\mathrm{o}}$	Over V <sub>in</sub> range, I <sub>o</sub> =1.5A	600	650	700	kHz
Absolute Maximum Operating Temperature Range	$T_a$	_	-40	_	+85	°C
Recommended Operating Temperature Range	$T_a$	Free Air Convection, (40-60LFM) At $V_{\rm in}$ = 24V, $I_{\rm o}$ =1.0A	-40	_	+80**	°C
Thermal Resistance	$\theta_{\mathrm{ja}}$	Free Air Convection, (40-60LFM)	_	45	_	°C/W
Storage Temperature	$T_s$	_	-40		+125	°C
Mechanical Shock	_	Per Mil-STD-883D, Method 2002.3	_	500	_	G's
Mechanical Vibration	_	Per Mil-STD-883D, Method 2007.2, 20-2000 Hz, soldered in a PC board	_	5	_	G's
Weight	_	_	_	6.5	_	grams

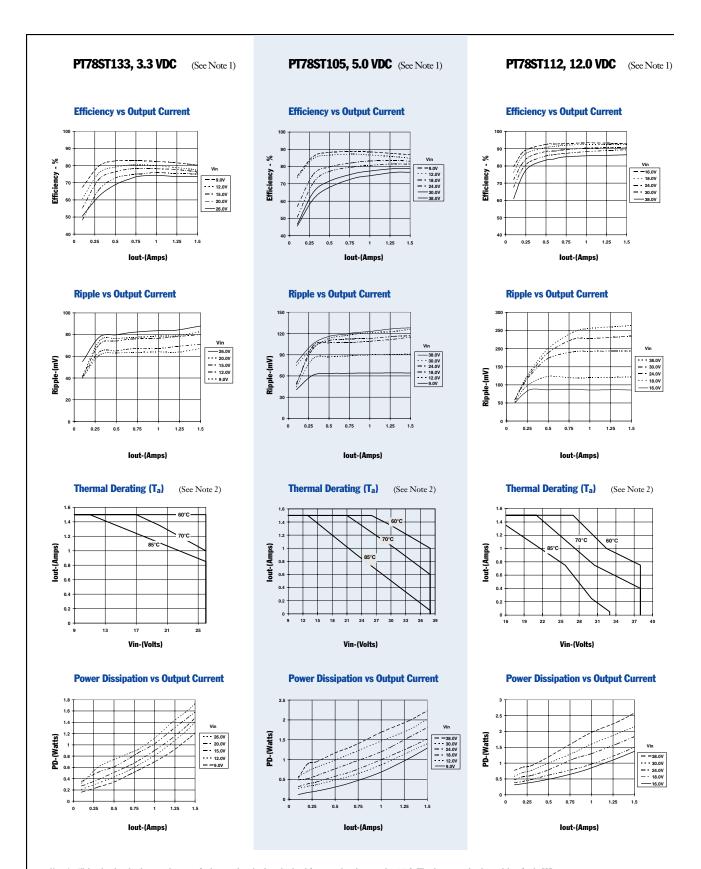
<sup>\*</sup>ISR will operate down to no load with reduced specifications.



<sup>\*\*</sup>See Thermal Derating chart.

Note: The PT78ST100 Series requires a 100µF electrolytic or tantalum output capacitor for proper operation in all applications.

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Note 1: All data listed in the above graphs, except for derating data, bas been developed from actual products tested at 25°C. This data is considered typical data for the ISR. Note 2: Thermal derating graphs are developed in free air convection cooling of 40-60 LFM. (See Thermal Application Notes.)







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# **PACKAGING INFORMATION**

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
PT78ST105H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST105S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST105ST	LIFEBUY	SIP MODULE	EFC	3	200	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST105U	LIFEBUY	SIP MODULE	EFU	3		TBD	Call TI	Call TI			
PT78ST105V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST106H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST106S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST106V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST107H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST107S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST107ST	OBSOLETI	SIP MODULE	EFC	3		TBD	Call TI	Call TI			
PT78ST108H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST108S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST108V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST109H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST109S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST109V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST110H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			





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Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
PT78ST110S	1 /	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM		( )	
PT78ST110V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST112H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST112S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST112V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST114S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST114V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST115H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST115S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST115ST	OBSOLETE	SIP MODULE	EFC	3		TBD	Call TI	Call TI			
PT78ST115V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST133H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST133S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST133V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST136H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST151H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST151S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST153H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			





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Orderable Device	Status	Package Type	_	Pins	Package Qty	Eco Plan	Lead/Ball Finish	MSL Peak Temp	Op Temp (°C)	Top-Side Markings	Samples
	(1)		Drawing			(2)		(3)		(4)	
PT78ST153S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST153V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST165H	LIFEBUY	SIP MODULE	EFA	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			
PT78ST165S	LIFEBUY	SIP MODULE	EFC	3	25	Pb-Free (RoHS)	Call TI	Level-1-215C-UNLIM			
PT78ST165V	LIFEBUY	SIP MODULE	EFD	3	25	Pb-Free (RoHS)	Call TI	N / A for Pkg Type			

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

**Pb-Free** (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes. **Pb-Free** (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between

the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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<sup>&</sup>lt;sup>(4)</sup> Only one of markings shown within the brackets will appear on the physical device.





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